Supply Chain Explorer

By the Emerging Technology Observatory

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Encapsulation resins

Protective ceramic packages, plastic substrates, or encapsulant resins may be bonded to a chip during the packaging process.

Country provision

- China (mainland)
- Germany
- Japan

Notable supplier companies

- HHCK - China (mainland)
- Henkel - Germany
- Hitachi - Japan
- Sinopaco - China (mainland)
- Sumitomo - Japan